

STRUCTURE	Silicon Monolithic Integrated Circuit
TYPE	1A Low Dropout Voltage Regulator with Shut Down Switch (Adjustable Voltage)
PRODUCT SERIES	BAXXCCOWT-V5 Series
FEATURES	Maximum Output Current : 1A High Input Voltage : 35V, Built in Over Voltage Protection

ABSOLUTE MAXIMUM RATINGS (Ta=25°C)

Parameter	Symbol	Limits	Unit
Supply Voltage	Vcc	-0.3 ~ 35 ※1	V
Output Control Voltage	Vctl	-0.3 ~ Vcc	V
Power Dissipation (TO252-5)	Pd	2000 ※2	mW
Operating Temperature Range	Topr	-40~+125	°C
Storage Temperature Range	Tstg	-55~+150	°C
Junction Temperature	Tjmax	150	°C
Peak Supply Voltage	Vcc peak	50 ※3	V

※1 Do not however exceed Pd.

※2 Derating is done at 16mW/°C for operating above Ta≥25°C.

※3 Bias voltage in 200msec (tr≥1msec). See NOTES FOR USE No.6.

RECOMMENDED OPERATING CONDITIONS (Ta=-40~125°C, however do not exceed Pd.)

Parameter	Symbol	Min.	Max.	Unit
Supply Voltage	Vcc	4.0	25.0	V
Output Current	Io	—	1.0	A

PROTECTION (Design Guarantee)

Parameter	Symbol	Min.	Typ.	Max.	Unit
Over Voltage Protection	Vcc	26	28	30	V

NOTE The product described in this specification is a strategic product (and/or service) subject to COCOM regulations. It should not be exported without authorization from the appropriate government.

NOTE This product is not designed for normal operation within a radio active environment.

Status of this document

The Japanese version of this document is the formal specification.

A customer may use this translation version only for a reference to help reading the formal version.

If there are any differences in translation version of this document, formal version takes priority.

OELECTRICAL CHARACTERISTIC (Unless otherwise specified, Ta=25°C, Vctl=5V, Io=500mA) ※1

Parameter	Symbol	Limit			Unit	Conditions
		Min.	Typ.	Max.		
Output Voltage ※2	Vo	Vo(T) × 0.98	Vo(T)	Vo(T) × 1.02	V	
Shut Down Current	I _{sd}	—	0	10	μA	VCTL=0V
Bias Current	I _b	—	2.5	5.0	mA	VCTL=2V, I _o =0mA
Dropout Voltage	ΔV _d	—	0.3	0.5	V	V _{cc} =Vo(T) × 0.95
Peak Output Current	I _o	1.0	—	—	A	
Ripple Rejection	R.R.	45	55	—	dB	f=120Hz, I _o =100mA, e _{in} *4=1Vrms
Line Regulation	Reg.I	—	20	100	mV	V _{cc} =Vo(T)+1→25V
Load Regulation	Reg.L	—	50	150	mV	I _o =5mA→1A
Temperature Coefficient of Output Current ※3	T _{cvo}	—	±0.02	—	%/°C	I _o =5mA, T _j =0~125°C
Output Short Current	I _{os}	—	0.40	—	A	V _{cc} =25V
ON Mode Voltage	V _{thH}	2.0	—	—	V	ACTIVE MODE, I _o =0mA
OFF Mode Voltage	V _{thL}	—	—	0.8	V	OFF MODE, I _o =0mA
Input High Current	I _{ctl}	100	200	300	μA	VCTL=5V, I _o =0mA

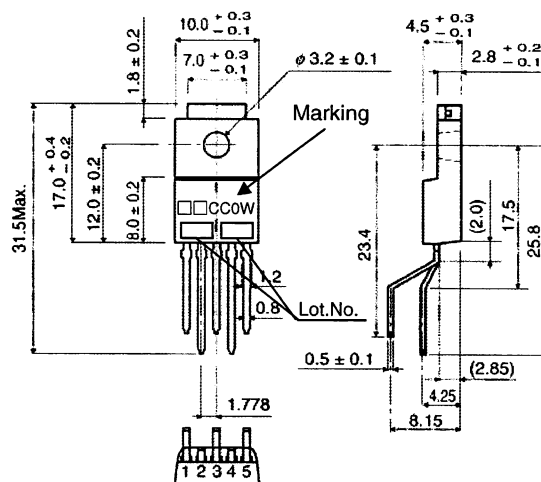
※1 Vo=3.3V:V_{cc}=8.3V, Vo=5V:V_{cc}=10V, Vo=8V:V_{cc}=13V, Vo=9V:V_{cc}=14V, Vo=12V:V_{cc}=17V

※2 Vo(T)=3.3, 5.0, 6.0, 7.0, 8.0, 9.0, 12.0V

※3 Design guarantee.(Outgoing inspection is not done on all products.)

※4 e_{in} : Input Voltage Ripple

OPHYSICAL DIMENSIONS, MARKING

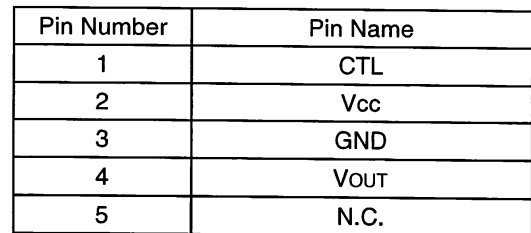


TO220FP-5(V5) (UNIT : mm)

OMARKING, OUTPUT VOLTAGE

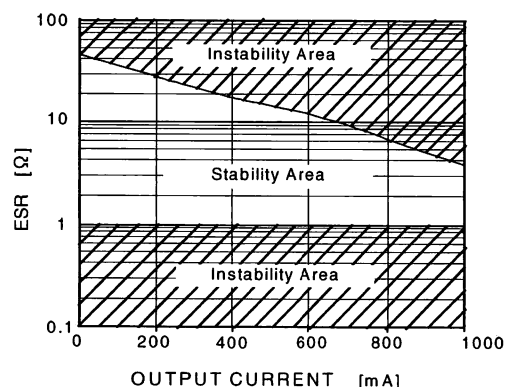
Parts Number	Marking	Output Voltage (V)	Parts Number	Marking	Output Voltage (V)
BA033CC0WT	033CC0W	3.3	BA09CC0WT	09CC0W	9.0
BA05CC0WT	05CC0W	5.0	BAJ2CC0WT	J2CC0W	12.0
BA08CC0WT	08CC0W	8.0			

OPIN NO. , PIN NAME



ONOTES FOR USE

- Keep capacitor capacitance within a range of $22\mu\text{F} \sim 1000\mu\text{F}$. It is also recommended that a $0.33\mu\text{F}$ bypass capacitor be connected as close to the input pin-GND as location possible. However, in situations such as rapid fluctuation of the input voltage or the load, please check the operation in real application to determine proper capacitance.



www.DataSheet4U.com

6. Over voltage protection circuit

The over voltage protection is useful for the sharp surge voltage.

(Rise Time: more than 1msec)

If the surge voltage is supplied for a longer time, another protection circuit (ex. power zenner) should be added.

7. Overcurrent protection circuit

The built-in overcurrent protection circuit is designed to respond to the output current and prevent destruction of the IC from load short circuits; however, it is only effective in protecting the IC from destruction in sudden overcurrent accidents. The protection circuit is not to be used continuously, or for transitions. In executing thermal design, bear in mind that overcurrent protection has negative characteristic according with the temperature.

8. Thermal shutdown circuit

A built-in internal shutdown (TSD) circuit is provided to protect the IC from heat destruction. Operation has to be done within the allowable loss range, but in continuous use beyond the range, chip temperature T_J will increase to the threshold, activating the TSD circuit and turning the output power Tr OFF. Once the chip temperature T_J returns to the normal range, the circuit is automatically restored. Note that the TSD circuit is designed to operate over the maximum absolute rating. Therefore, make absolutely certain not to use the TSD function in set design.

9. Mounting Failures

Mounting failure, such as misdirection or mismount, may cause a malfunction in the device.

10. Internal circuits or elements may be damaged when Vcc and pin voltage are reversed. For example, Vcc short circuit to GND while a external capacitor is charged. Output pin capacitor is recommended no larger than 1000 μ F. In addition, inserting a Vcc series countercurrent prevention diode, or a bypass diode between the various pins and the vcc, is recommended.

11. Malfunction may be happened when the device is used in the strong electromagnetic field.

12. We recommend to put Diode for protection purpose in case of output pin connected with large load of impedance or reserve current occurred at initial and output off.

13. Precautions for board inspection

Connecting low-impedance capacitors to run inspections with the board may produce stress on the IC. Therefore, be certain to use proper discharge procedure before each process of the test operation. To prevent electrostatic accumulation and discharge in the assembly process, thoroughly ground yourself and any equipment that could sustain ESD damage, and continue observing ESD-prevention procedures in all handling, transfer and storage operations. Before attempting to connect components to the test setup, make certain that the power supply is OFF. Likewise, be sure the power supply is OFF before removing any component connected to the test setup.

14. GND pattern

When both a small-signal GND and high current GND are present, single-point grounding (at the set standard point) is recommended, in order to separate the small-signal and high current patterns, and to be sure the voltage change stemming from the wiring resistance and high current does not cause any voltage change in the small-signal GND. In the same way, care must be taken to avoid voltage fluctuations in any connected external component GND.

Notes

- No technical content pages of this document may be reproduced in any form or transmitted by any means without prior permission of ROHM CO.,LTD.
- The contents described herein are subject to change without notice. The specifications for the product described in this document are for reference only. Upon actual use, therefore, please request that specifications to be separately delivered.
- Application circuit diagrams and circuit constants contained herein are shown as examples of standard use and operation. Please pay careful attention to the peripheral conditions when designing circuits and deciding upon circuit constants in the set.
- Any data, including, but not limited to application circuit diagrams information, described herein are intended only as illustrations of such devices and not as the specifications for such devices. ROHM CO.,LTD. disclaims any warranty that any use of such devices shall be free from infringement of any third party's intellectual property rights or other proprietary rights, and further, assumes no liability of whatsoever nature in the event of any such infringement, or arising from or connected with or related to the use of such devices.
- Upon the sale of any such devices, other than for buyer's right to use such devices itself, resell or otherwise dispose of the same, no express or implied right or license to practice or commercially exploit any intellectual property rights or other proprietary rights owned or controlled by
- ROHM CO., LTD. is granted to any such buyer.
- Products listed in this document are no antiradiation design.

The products listed in this document are designed to be used with ordinary electronic equipment or devices (such as audio visual equipment, office-automation equipment, communications devices, electrical appliances and electronic toys).

Should you intend to use these products with equipment or devices which require an extremely high level of reliability and the malfunction of which would directly endanger human life (such as medical instruments, transportation equipment, aerospace machinery, nuclear-reactor controllers, fuel controllers and other safety devices), please be sure to consult with our sales representative in advance.

About Export Control Order in Japan

Products described herein are the objects of controlled goods in Annex 1 (Item 16) of Export Trade Control Order in Japan.

In case of export from Japan, please confirm if it applies to "objective" criteria or an "informed" (by MITI clause) on the basis of "catch all controls for Non-Proliferation of Weapons of Mass Destruction.

Thank you for your accessing to ROHM product informations.
More detail product informations and catalogs are available,
please contact your nearest sales office.

Please contact our sales offices for details ;

U.S.A / San Diego	TEL : +1(858)625-3630	FAX : +1(858)625-3670
Atlanta	TEL : +1(770)754-5972	FAX : +1(770)754-0691
Dallas	TEL : +1(972)312-8818	FAX : +1(972)312-0330
Germany / Dusseldorf	TEL : +49(2154)9210	FAX : +49(2154)921400
United Kingdom / London	TEL : +44(1)908-282-666	FAX : +44(1)908-282-528
France / Paris	TEL : +33(0)1 56 97 30 60	FAX : +33(0) 1 56 97 30 80
China / Hong Kong	TEL : +852(2)740-6262	FAX : +852(2)375-8971
Shanghai	TEL : +86(21)6279-2727	FAX : +86(21)6247-2066
Dalian	TEL : +86(411)8230-8549	FAX : +86(411)8230-8537
Beijing	TEL : +86(10)8525-2483	FAX : +86(10)8525-2489
Taiwan / Taipei	TEL : +866(2)2500-6956	FAX : +866(2)2503-2869
Korea / Seoul	TEL : +82(2)8182-700	FAX : +82(2)8182-715
Singapore	TEL : +65-6332-2322	FAX : +65-6332-5662
Malaysia / Kuala Lumpur	TEL : +60(3)7958-8355	FAX : +60(3)7958-8377
Philippines / Manila	TEL : +63(2)807-6872	FAX : +63(2)809-1422
Thailand / Bangkok	TEL : +66(2)254-4890	FAX : +66(2)256-6334

Japan /
(Internal Sales)

Tokyo	2-1-1, Yaesu, Chuo-ku, Tokyo 104-0082	TEL : +81(3)5203-0321	FAX : +81(3)5203-0300
Yokohama	2-4-8, Shin Yokohama, Kohoku-ku, Yokohama, Kanagawa 222-8575	TEL : +81(45)476-2131	FAX : +81(45)476-2128
Nagoya	Dainagayo Building 9F 3-28-12, Meieki, Nakamura-ku, Nagoya, Aichi 450-0002	TEL : +81(52)581-8521	FAX : +81(52)561-2173
Kyoto	579-32 Higashi Shiokouji-cho, Karasuma Nishi-iru, Shiokoujidori, Shimogyo-ku, Kyoto 600-8216	TEL : +81(75)311-2121	FAX : +81(75)314-6559
(Contact address for overseas customers in Japan)			
Yokohama		TEL : +81(45)476-9270	FAX : +81(045)476-9271

As of 18th. April 2005